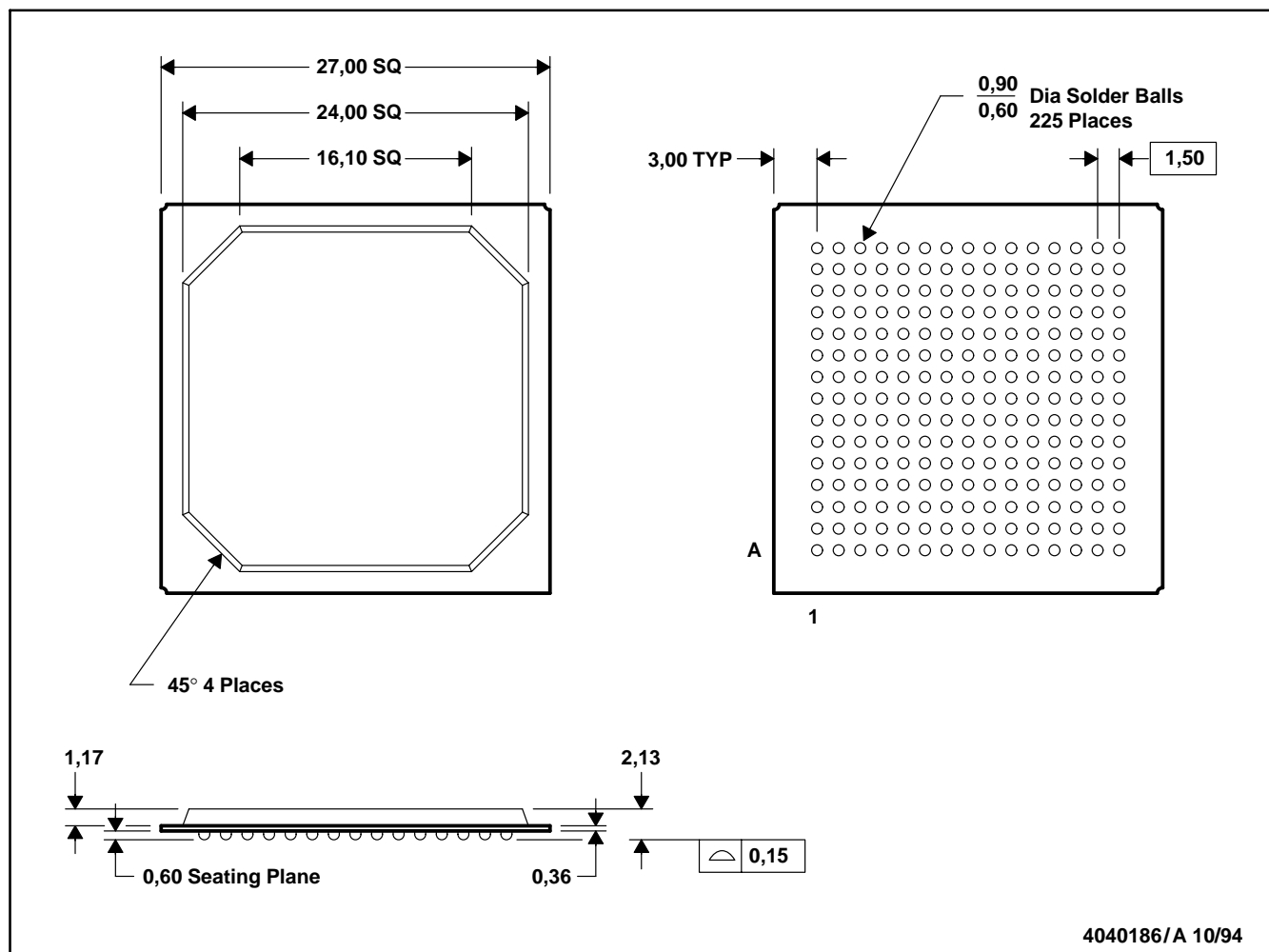


GFM (S-PBGA-N225)

PLASTIC BALL GRID ARRAY PACKAGE



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